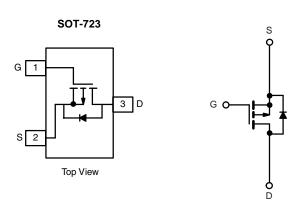


P-Channel 20 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|-----------------------------------|--------------------|----------------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (TYP.) (nC) | | | |
| | 0.450 at V _{GS} = -4.5 V | -0.55 | | | | |
| -20 | 0.500 at V _{GS} = -2.5 V | -0.50 | 1 | | | |
| | 0.600 at V _{GS} = -1.8 V | -0.38 | | | | |



P-Channel MOSFET

FEATURES

- TrenchFET® power MOSFET
- 100 % R tested
- Fast switching speed



APPLICATIONS

- Load / power switch for portable devices
- Drivers: relays, solenoids, displays
- Battery operated systems

| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | | | |
|----------------------------------------------------------------------------------|------------------------|-----------------------------------|-----------------------|----|--|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | | |
| Drain-Source Voltage | V _{DS} | -20 | V | | | |
| Gate-Source Voltage | | V_{GS} | ± 8 | V | | |
| Continuous Drain Current (T _{.I} = 150 °C) | T _A = 25 °C | - I _D | -0.55 ^{b, c} | Α | | |
| Continuous Drain Current (1) = 130 C) | T _A = 70 °C | | -0.45 ^{b, c} | | | |
| Pulsed Drain Current (t = 300 μs) | | I _{DM} | -1.8 | | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | -0.16 ^{b, c} | | | |
| Maximum Power Dissipation | T _A = 25 °C | - P _D | 0.19 ^{b, c} | W | | |
| Maximum Fower Dissipation | T _A = 70 °C | ГД | 0.12 ^{b, c} | | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---------------------------------------------|--------------|-------------------|---------|---------|------|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | |
| Maximum Junction-to-Ambient ^{a, b} | t ≤ 5 s | R_{thJA} | 440 | 530 | °C/W | |
| Waximum Junction-to-Ambient 4, 2 | Steady State | | 540 | 650 | C/VV | |

Notes

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- $c. \ t=5 \ s.$

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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|-----------------------------------------------|-------------------------|------------------------------------------------------------------------|------------------------------|-------|------|--------|--|
| Static | | | | • | I. | • | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0$, $I_D = -250 \mu A$ | -20 | _ | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | J 250 | | -12 | - | m\//°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = -250 μA | - | 1.8 | - | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | -0.4 | - | -1 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | - | - | ± 30 | 1 | |
| Gate-Source Leakage | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$ | - | - | ± 1 | | |
| Zoro Goto Voltago Drain Current | l | V _{DS} = -20 V, V _{GS} = 0 V | -20 V, V _{GS} = 0 V | | -1 | - μΑ | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = -20 V, V _{GS} = 0 V, T _J = 85 °C | - | - | -10 | 1 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$ | -1.5 | - | - | Α | |
| | | $V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$ | - | 0.450 | - | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -2.5 \text{ V}, I_D = -0.2 \text{ A}$ | - | 0.500 | - | Ω | |
| | | V _{GS} = -1.8 V, I _D = -0.1 A | - | 0.600 | - | 1 | |
| Forward Transconductance | 9fs | $V_{DS} = -10 \text{ V}, I_D = 0.4 \text{ A}$ | - | 1 | - | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | - | 45 | - | pF | |
| Output Capacitance | C _{oss} | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 15 | - | | |
| Reverse Transfer Capacitance | C _{rss} | | - | 10 | - | | |
| Total Gate Charge | Q _g | V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -0.4 A | - | 1.65 | 2.50 | | |
| Total Gate Offarge | | | - | 1 | 2 | nC | |
| Gate-Source Charge | Q_{gs} | V_{DS} = -0 V, V_{GS} = -2.5 V, I_D = -0.4 | - | 0.2 | - | | |
| Gate-Drain Charge | Q_{gd} | | - | 0.26 | - | | |
| Gate Resistance | R_g | f = 1 MHz | 2.4 | 12 | 24 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | - | 9 | 18 | | |
| Rise Time | t _r | V_{DD} = -10 V, R_L = 33.3 Ω | - | 10 | 20 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D\cong$ -0.3 A, V_{GEN} = -4.5 V, R_g = 1 Ω | - | 10 | 20 | | |
| Fall Time | t _f | | - | 8 | 16 | ne | |
| Turn-On Delay Time | t _{d(on)} | | - | 1 | 2 | ns | |
| Rise Time | t _r | V_{DD} = -10 V, R_L = 33.3 Ω | - | 8 | 16 |] | |
| Turn-Off DelayTime | t _{d(off)} | $I_D\cong$ -0.3 A, $V_{GEN}=$ -8 V, $R_g=$ 1 Ω | - | 9 | 18 |] | |
| Fall Time | t _f | | - | 5 | 10 | | |
| Drain-Source Body Diode Characteris | tics | | | | | | |
| Pulse Diode Forward Current ^a | I _{SM} | | - | - | -1.5 | Α | |
| Body Diode Voltage | V_{SD} | $I_S = -0.3 \text{ A}$ | - | -0.8 | -1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | - | 16 | 24 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | $I_F = -0.3 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s}$ | | 8 | 16 | nC | |
| Reverse Recovery Fall Time | ta | | | 11 | - | ns | |
| Reverse Recovery Rise Time | t _b | | - | 5 | = | | |

Notes

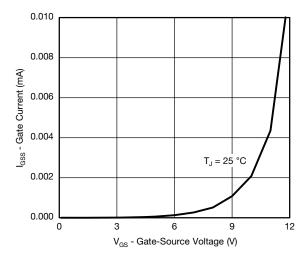
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

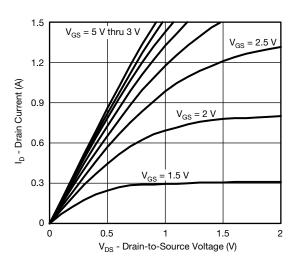
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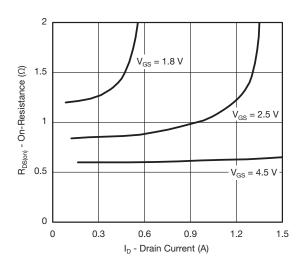
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



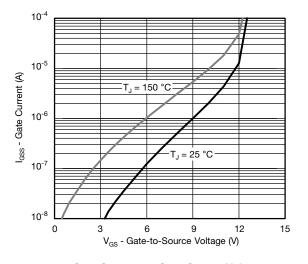
Gate Current vs. Gate-Source Voltage



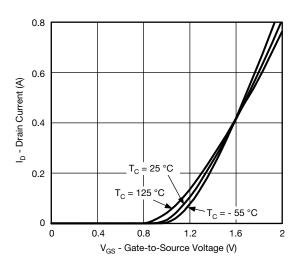
Output Characteristics



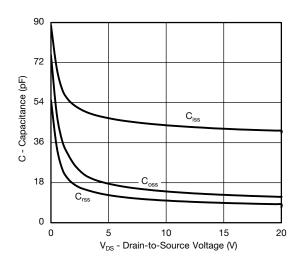
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



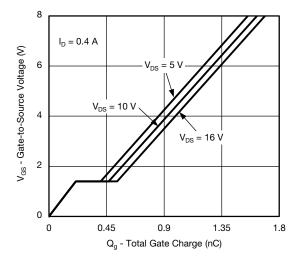
Transfer Characteristics



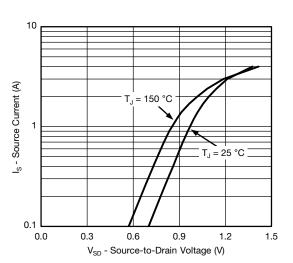
Capacitance



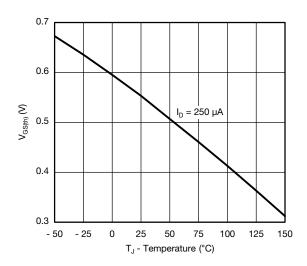
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



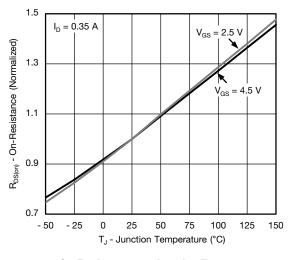
Gate Charge



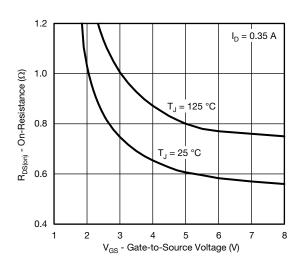
Source-Drain Diode Forward Voltage



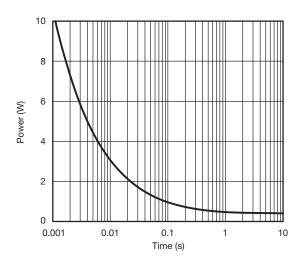
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

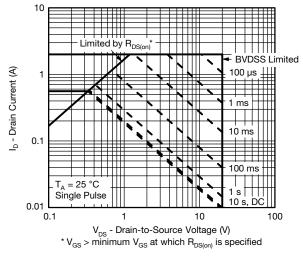


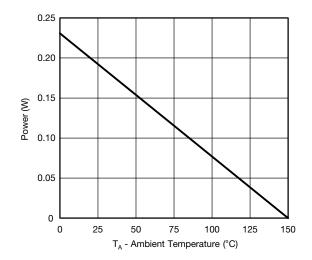
Single Pulse Power, Junction-to-Ambient

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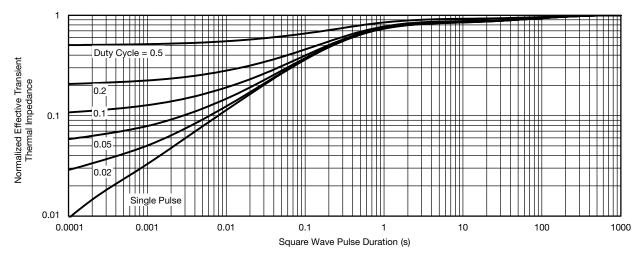
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Safe Operating Area, Junction-to-Ambient

Power Derating, Junction-to-Ambient

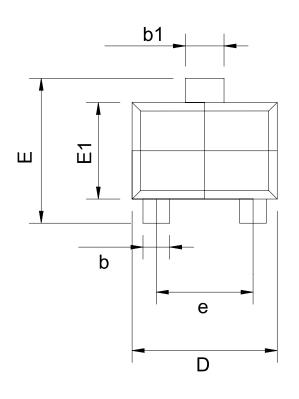


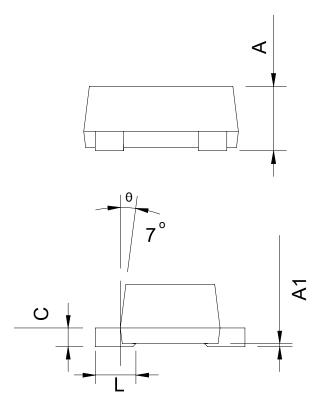
Normalized Thermal Transient Impedance, Junction-to-Ambient

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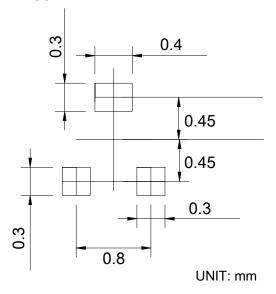
SOT-723: 3 Leads





| Ş | SOT-723 | | | | | |
|-----------------|------------|-------|------------|-------|--|--|
| %≻ <u>Sm</u> OL | MILLIM | ETERS | INCHES | | | |
| | MIN. | MAX. | MIN. | MAX. | | |
| Α | - | 0.500 | - | 0.020 | | |
| A1 | 0.000 | 0.050 | 0.000 | 0.002 | | |
| b | 0.170 | 0.270 | 0.007 | 0.011 | | |
| b1 | 0.270 | 0.370 | 0.011 | 0.015 | | |
| С | - | 0.150 | - | 0.006 | | |
| D | 1.150 | 1.250 | 0.045 | 0.049 | | |
| Е | 1.150 | 1.250 | 0.045 | 0.049 | | |
| E1 | 0.750 | 0.850 | 0.030 | 0.033 | | |
| е | 0.800 TYP. | | 0.031 TYP. | | | |
| L | 0.32 BSC | | 0.013 BSC | | | |
| _ | ° REF. | | °REF. | | | |

RECOMMENDED LAND PATTERN



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